

The RF Sub-Micron MOSFET Line

RF Power Field Effect Transistors

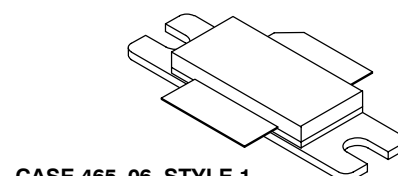
N-Channel Enhancement-Mode Lateral MOSFETs

MRF9135LR3
MRF9135LSR3

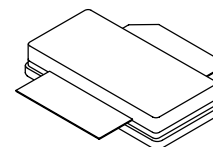
Designed for broadband commercial and industrial applications with frequencies from 865 to 895 MHz. The high gain and broadband performance of these devices make them ideal for large-signal, common-source amplifier applications in 26 volt base station equipment.

- Typical N-CDMA Performance @ 880 MHz, 26 Volts, $I_{DQ} = 1100$ mA
IS-95 CDMA Pilot, Sync, Paging, Traffic Codes 8 Through 13
Output Power — 25 Watts Avg.
Power Gain — 17.8 dB
Efficiency — 25%
Adjacent Channel Power —
750 kHz: -47 dBc @ 30 kHz BW
- Internally Matched, for Ease of Use
- High Gain, High Efficiency and High Linearity
- Integrated ESD Protection
- Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 10:1 VSWR, @ 26 Vdc, 880 MHz, 135 Watts CW Output Power
- Excellent Thermal Stability
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- Low Gold Plating Thickness on Leads, 40μ" Nominal.
- In Tape and Reel. R3 Suffix = 250 Units per 32 mm, 13 inch Reel.

880 MHz, 135 W, 26 V
LATERAL N-CHANNEL
RF POWER MOSFETs



CASE 465-06, STYLE 1
NI-780
MRF9135LR3



CASE 465A-06, STYLE 1
NI-780S
MRF9135LSR3

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	65	Vdc
Gate-Source Voltage	V_{GS}	- 0.5, +15	Vdc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	298 1.7	Watts W/ $^\circ\text{C}$
Storage Temperature Range	T_{stg}	- 65 to +200	$^\circ\text{C}$
Operating Junction Temperature	T_J	200	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.6	$^\circ\text{C/W}$

ESD PROTECTION CHARACTERISTICS

Test Conditions	Class
Human Body Model	1 (Minimum)
Machine Model	M2 (Minimum)
Charge Device Model	C7 (Minimum)

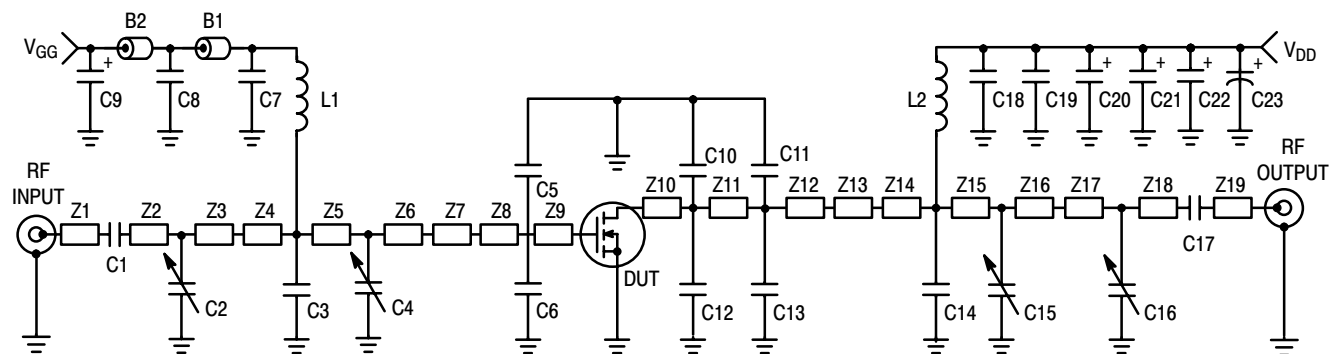
NOTE - **CAUTION** - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

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ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$, 50 ohm system unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Zero Gate Voltage Drain Leakage Current ($V_{DS} = 65\text{ Vdc}$, $V_{GS} = 0\text{ Vdc}$)	I_{DSS}	—	—	10	μAdc
Zero Gate Voltage Drain Leakage Current ($V_{DS} = 26\text{ Vdc}$, $V_{GS} = 0\text{ Vdc}$)	I_{DSS}	—	—	1	μAdc
Gate-Source Leakage Current ($V_{GS} = 5\text{ Vdc}$, $V_{DS} = 0\text{ Vdc}$)	I_{GSS}	—	—	1	μAdc
ON CHARACTERISTICS					
Gate Threshold Voltage ($V_{DS} = 10\text{ Vdc}$, $I_D = 450\text{ }\mu\text{A}$)	$V_{GS(th)}$	2	2.8	4	Vdc
Gate Quiescent Voltage ($V_{DS} = 26\text{ Vdc}$, $I_D = 1100\text{ mAdc}$)	$V_{GS(Q)}$	3	3.7	5	Vdc
Drain-Source On-Voltage ($V_{GS} = 10\text{ Vdc}$, $I_D = 3\text{ Adc}$)	$V_{DS(on)}$	—	0.19	0.4	Vdc
Forward Transconductance ($V_{DS} = 10\text{ Vdc}$, $I_D = 9\text{ Adc}$)	g_{fs}	—	12	—	S
DYNAMIC CHARACTERISTICS					
Output Capacitance ($V_{DS} = 26\text{ Vdc} \pm 30\text{ mV(rms)}$ ac @ 1 MHz, $V_{GS} = 0\text{ Vdc}$)	C_{oss}	—	109	—	pF
Reverse Transfer Capacitance ($V_{DS} = 26\text{ Vdc} \pm 30\text{ mV(rms)}$ ac @ 1 MHz, $V_{GS} = 0\text{ Vdc}$)	C_{rss}	—	4.4	—	pF
FUNCTIONAL TESTS (In Motorola Test Fixture, 50 ohm system) Single-Carrier N-CDMA, 1.2288 MHz Channel Bandwidth Carrier, Peak/Avg. Ratio = 9.8 dB @ 0.01% Probability on CCDF					
Common-Source Amplifier Power Gain ($V_{DD} = 26\text{ Vdc}$, $P_{out} = 25\text{ W Avg. N-CDMA}$, $I_{DQ} = 1100\text{ mA}$, $f = 880.0\text{ MHz}$)	G_{ps}	16	17.8	—	dB
Drain Efficiency ($V_{DD} = 26\text{ Vdc}$, $P_{out} = 25\text{ W Avg. N-CDMA}$, $I_{DQ} = 1100\text{ mA}$, $f = 880.0\text{ MHz}$)	η	22	25	—	%
Adjacent Channel Power Ratio ($V_{DD} = 26\text{ Vdc}$, $P_{out} = 25\text{ W Avg. N-CDMA}$, $I_{DQ} = 1100\text{ mA}$, $f = 880.0\text{ MHz}$; ACPR @ 25 W, 1.23 MHz Bandwidth, 750 kHz Channel Spacing)	ACPR	—	-47	-45	dBc
Input Return Loss ($V_{DD} = 26\text{ Vdc}$, $P_{out} = 25\text{ W Avg. N-CDMA}$, $I_{DQ} = 1100\text{ mA}$, $f = 880.0\text{ MHz}$)	IRL	—	-13.5	-9	dB
Common-Source Amplifier Power Gain ($V_{DD} = 26\text{ Vdc}$, $P_{out} = 25\text{ W Avg. N-CDMA}$, $I_{DQ} = 1100\text{ mA}$, $f = 865\text{ MHz}$ and 895 MHz)	G_{ps}	—	17	—	dB
Drain Efficiency ($V_{DD} = 26\text{ Vdc}$, $P_{out} = 25\text{ W Avg. N-CDMA}$, $I_{DQ} = 1100\text{ mA}$, $f = 865\text{ MHz}$ and 895 MHz)	η	—	24	—	%
Adjacent Channel Power Ratio ($V_{DD} = 26\text{ Vdc}$, $P_{out} = 25\text{ W Avg. N-CDMA}$, $I_{DQ} = 1100\text{ mA}$, $f = 865\text{ MHz}$ and 895 MHz ; ACPR @ 25 W, 1.23 MHz Bandwidth, 750 kHz Channel Spacing)	ACPR	—	-46	—	dBc
Input Return Loss ($V_{DD} = 26\text{ Vdc}$, $P_{out} = 25\text{ W Avg. N-CDMA}$, $I_{DQ} = 1100\text{ mA}$, $f = 865\text{ MHz}$ and 895 MHz)	IRL	—	-12.5	—	dB
Output Mismatch Stress ($V_{DD} = 26\text{ Vdc}$, $P_{out} = 135\text{ W CW}$, $I_{DQ} = 1100\text{ mA}$, $f = 880.0\text{ MHz}$, VSWR = 10:1, All Phase Angles at Frequency of Tests)	Ψ	No Degradation In Output Power			

Freescale Semiconductor, Inc.



Z1	0.430" x 0.080" Microstrip	Z11	0.105" x 0.630" Microstrip
Z2	0.430" x 0.080" Microstrip	Z12	0.145" x 0.630" Microstrip
Z3	0.800" x 0.080" Microstrip	Z13	0.200" x 0.630" x 0.220" Taper
Z4	0.200" x 0.220" Microstrip	Z14	0.180" x 0.220" Microstrip
Z5	0.110" x 0.220" Microstrip	Z15	0.110" x 0.220" Microstrip
Z6	0.175" x 0.220" Microstrip	Z16	0.200" x 0.220" Microstrip
Z7	0.200" x 0.220" x 0.630" Taper	Z17	0.900" x 0.080" Microstrip
Z8	0.250" x 0.630" Microstrip	Z18	0.360" x 0.080" Microstrip
Z9	0.050" x 0.630" Microstrip	Z19	0.410" x 0.080" Microstrip
Z10	0.050" x 0.630" Microstrip	PCB	Arlon GX-0300-55-22, 0.030", $\epsilon_r = 2.55$

Figure 1. 880 MHz Test Circuit Schematic

Table 1. 880 MHz Test Circuit Component Designations and Values

Part	Description	Value, P/N or DWG	Manufacturer
B1, B2	Short Ferrite Beads, Surface Mount	95F786	Newark
C1, C7, C17, C18	47 pF Chip Capacitors, B Case	100B470JP 500X	ATC
C2, C16	0.6-4.5 Gigatrim Variable Capacitors	44F3360	Newark
C3	8.2 pF Chip Capacitor, B Case	100B8R2BP 500X	ATC
C4, C15	0.8-8.0 Gigatrim Variable Capacitors	44F3360	Newark
C5, C6	12 pF Chip Capacitors, B Case	100B120JP 500X	ATC
C8	20K pF Chip Capacitor, B Case	200B203MP50X	ATC
C9, C20, C21, C22	10 μ F, 35 V Tantalum Capacitors	93F2975	Newark
C10, C11, C12, C13	7.5 pF Chip Capacitors, B Case	100B7R5JP 500X	ATC
C14	11 pF Chip Capacitor, B Case	100B110JP 500X	ATC
C19	0.56 μ F, 50 V Chip Capacitor	C1825C564K5RA7800	Kemet
C23	470 μ F Electrolytic Capacitor	14F185	Newark
L1, L2	12.5 nH Coilcraft inductors	A04T-5	Coilcraft
WB1, WB2	10 mil Brass Shim (0.205 x 0.530)	RF-Design Lab	RF-Design Lab

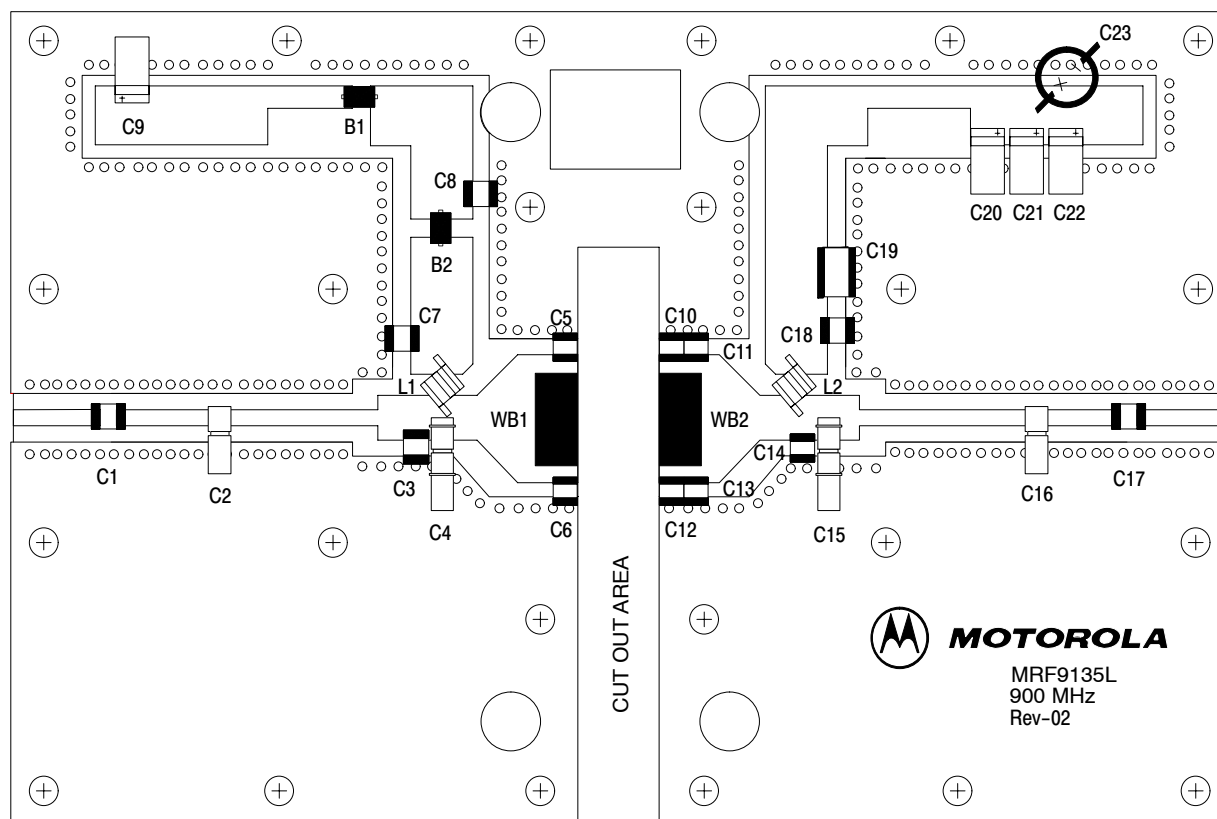


Figure 2. 880 MHz Test Circuit Component Layout

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TYPICAL CHARACTERISTICS

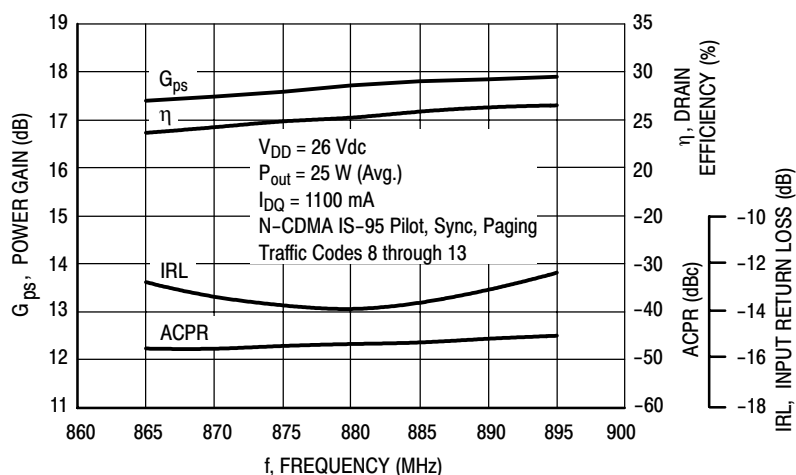


Figure 3. Class AB Broadband Circuit Performance

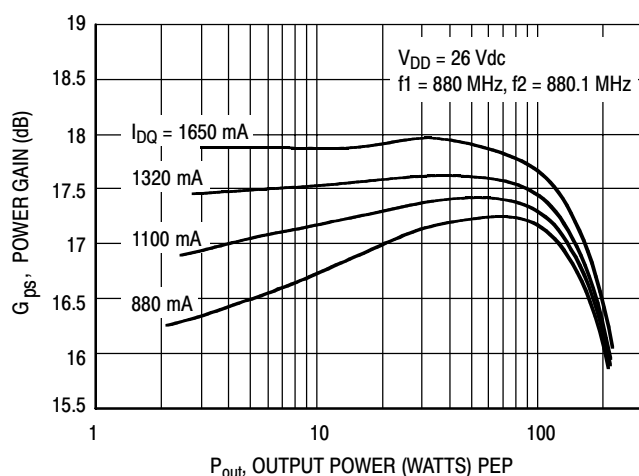


Figure 4. Power Gain versus Output Power

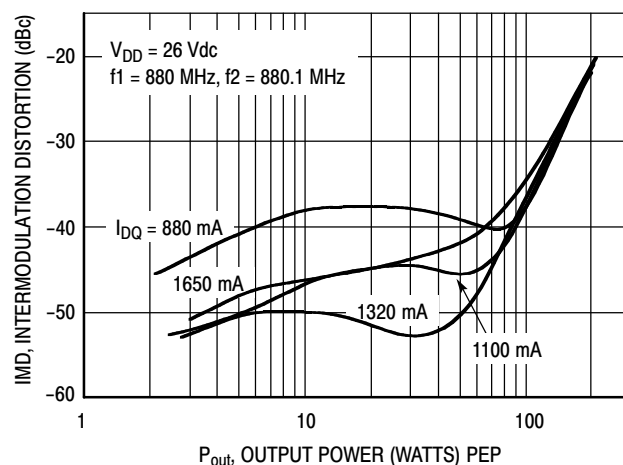


Figure 5. Intermodulation Distortion versus Output Power

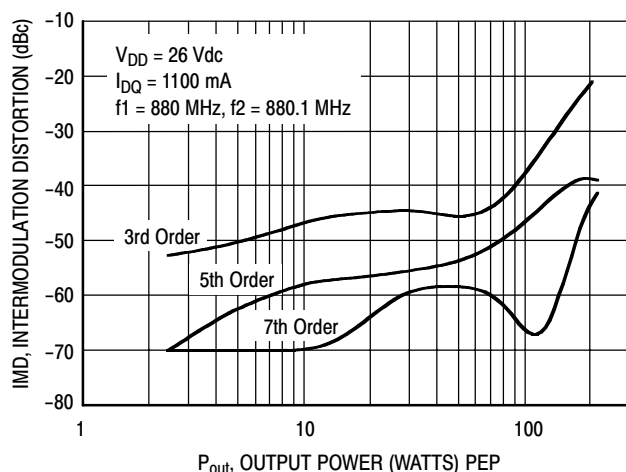


Figure 6. Intermodulation Distortion Products versus Output Power

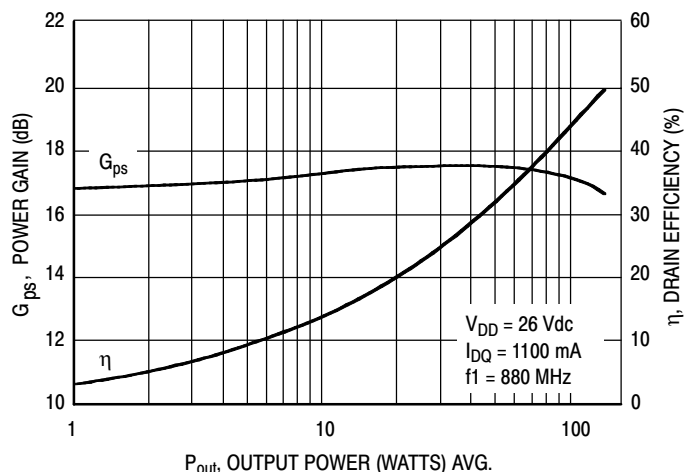


Figure 7. Power Gain and Efficiency versus Output Power

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TYPICAL CHARACTERISTICS

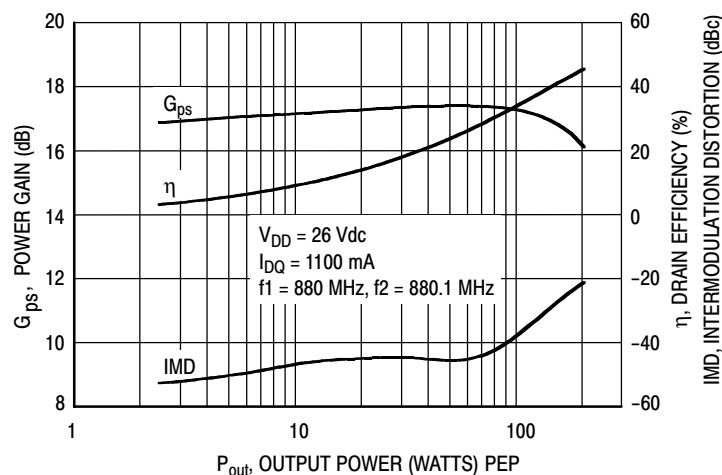


Figure 8. Power Gain, Efficiency and IMD versus Output Power

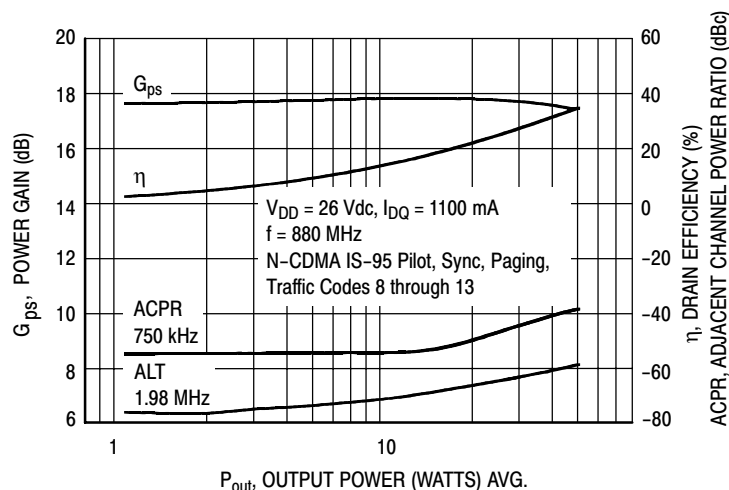


Figure 9. N-CDMA Performance Output Power versus Gain, ACPR, Efficiency

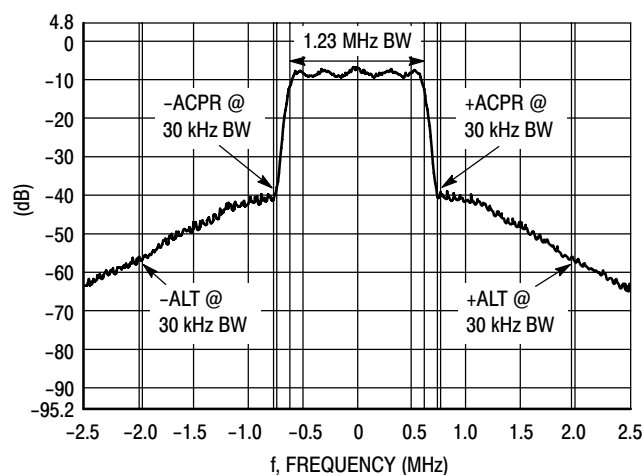
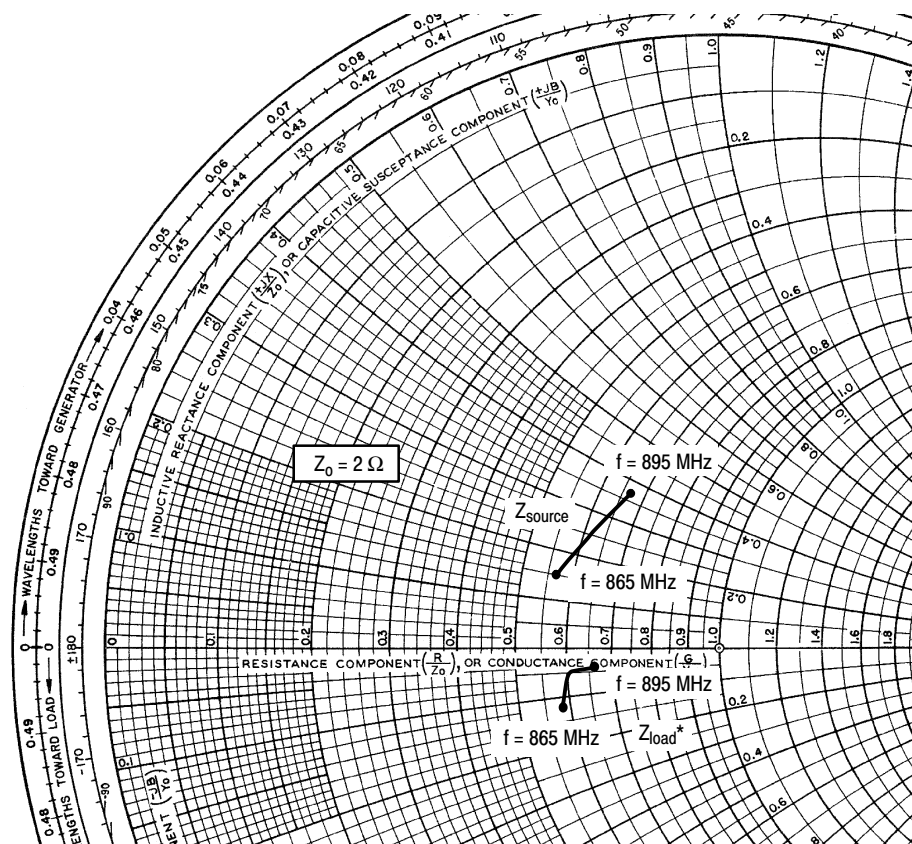


Figure 10. Typical CDMA Spectrum



$V_{DD} = 26 \text{ V}$, $I_{DQ} = 1100 \text{ mA}$, $P_{\text{out}} = 25 \text{ W Avg.}$

f MHz	Z_{source} Ω	Z_{load} Ω
865	$1.15 + j0.3$	$1.17 - j0.24$
880	$1.25 + j0.5$	$1.22 - j0.1$
895	$1.35 + j0.75$	$1.32 - j0.07$

Z_{source} = Test circuit impedance as measured from gate to ground.

Z_{load} = Test circuit impedance as measured from drain to ground.

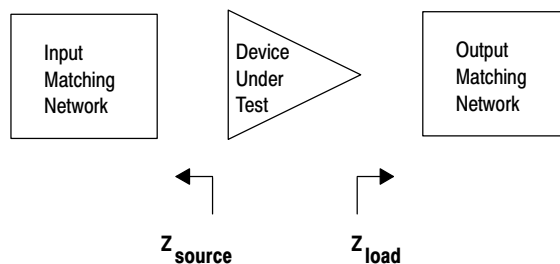


Figure 11. Series Equivalent Input and Output Impedance

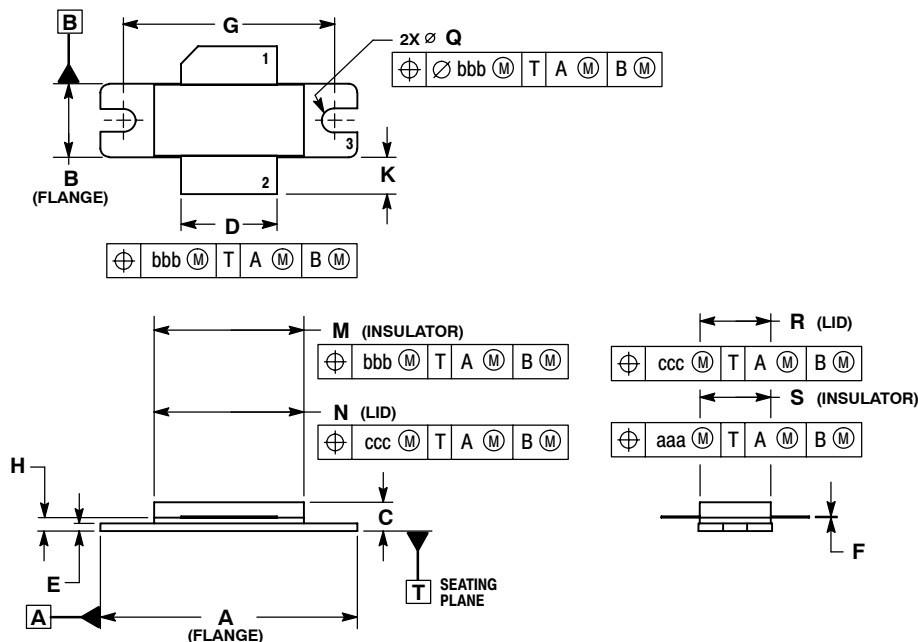
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PACKAGE DIMENSIONS



NOTES:

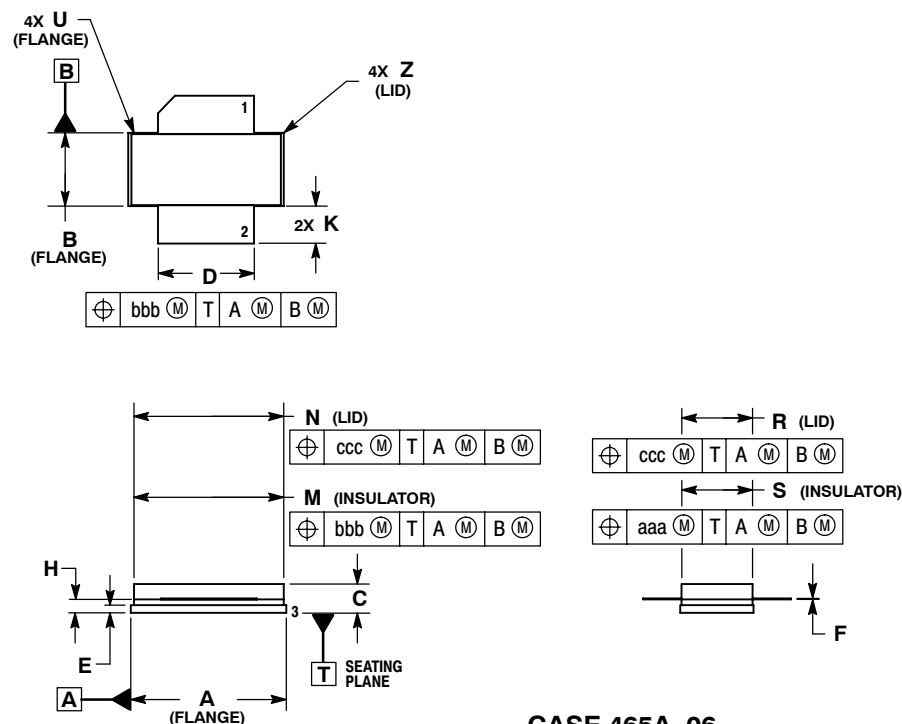
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1994.
2. CONTROLLING DIMENSION: INCH.
3. DELETED
4. DIMENSION H IS MEASURED 0.030 (0.762) AWAY FROM PACKAGE BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.335	1.345	33.91	34.16
B	0.380	0.390	9.65	9.91
C	0.125	0.170	3.18	4.32
D	0.495	0.505	12.57	12.83
E	0.035	0.045	0.89	1.14
F	0.003	0.006	0.08	0.15
G	1.100 BSC		27.94 BSC	
H	0.057	0.067	1.45	1.70
K	0.170	0.210	4.32	5.33
M	0.774	0.786	19.66	19.96
N	0.772	0.788	19.60	20.00
Q	$\varnothing$ 0.118	$\varnothing$ 0.138	$\varnothing$ 3.00	$\varnothing$ 3.51
R	0.365	0.375	9.27	9.53
S	0.365	0.375	9.27	9.52
aaa	0.005 REF		0.127 REF	
bbb	0.010 REF		0.254 REF	
ccc	0.015 REF		0.381 REF	

STYLE 1:

- PIN 1. DRAIN
- GATE
- SOURCE

**CASE 465-06
ISSUE F
NI-780
MRF9135LR3**



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1994.
2. CONTROLLING DIMENSION: INCH.
3. DELETED
4. DIMENSION H IS MEASURED 0.030 (0.762) AWAY FROM PACKAGE BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.805	0.815	20.45	20.70
B	0.380	0.390	9.65	9.91
C	0.125	0.170	3.18	4.32
D	0.495	0.505	12.57	12.83
E	0.035	0.045	0.89	1.14
F	0.003	0.006	0.08	0.15
H	0.057	0.067	1.45	1.70
K	0.170	0.210	4.32	5.33
M	0.774	0.786	19.61	20.02
N	0.772	0.788	19.61	20.02
R	0.365	0.375	9.27	9.53
S	0.365	0.375	9.27	9.52
U	---	0.040	---	1.02
Z	---	0.030	---	0.76
aaa	0.005 REF		0.127 REF	
bbb	0.010 REF		0.254 REF	
ccc	0.015 REF		0.381 REF	

STYLE 1:

- PIN 1. DRAIN
- GATE
- SOURCE

**CASE 465A-06
ISSUE F
NI-780S
MRF9135LSR3**

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MRF9135L/D